STX93003

HIGH VOLTAGE FAST-SWITCHING PNP POWER TRANSISTOR

- ST93003 SILICON IN TO-92 PACKAGE
- MEDIUM VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

APPLICATIONS:

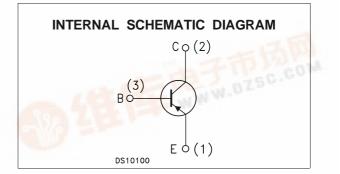
 ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING

DESCRIPTION

The device is manufactured using high voltage Multi-Epitaxial Planar technology for high switching speeds and medium voltage capability. It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The STX93003 is expressly designed for a new solution to be used in compact fluorescent lamps, where it is coupled with the STX83003, its complementary NPN transistor.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit V	
Vces	Collector-Emitter Voltage (V _{BE} = 0)	-500		
V_{CEO}	Collector-Emitter Voltage $(I_B = 0)$	-400	V	
V_{EBO}	Emitter-Base Voltage ($I_c = 0$) ($I_c = 0$, $I_B = -0.5 A$, $t_p < 10\mu s$, $T_j < 150^{\circ}C$)	V _{(BR)EBO}	V	
Ι _C	Collector Current	-1	Α	
I _{CM}	Collector Peak Current (t _p < 5 ms)	-3	Α	
IB	Base Current	-0.5	Α	
I _{BM}	Base Peak Current (t _p < 5 ms)	-1.5	Α	
Ptot	Total Dissipation at $T_{\rm C}$ = 25 °C	1.5	W	
T _{stg}	Storage Temperature -65 to 150		°C	
Tj	Max. Operating Junction Temperature	150	°C	



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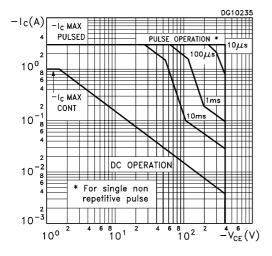
THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-Case	Max	83.3	°C/W
R _{thj-Amb}	Thermal Resistance Junction-Ambient	Max	200	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25 \ ^{\circ}C$ unless otherwise specified)

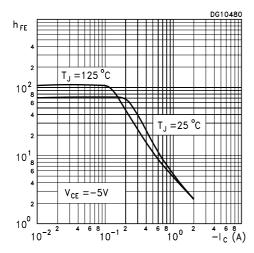
Symbol	Parameter	Test	Test Conditions			Max.	Unit
ICES	Collector Cut-off Current (V _{BE} = 0)	V _{CE} = -500V V _{CE} = -500V	T _j = 125 ^o C			-1 -5	mA mA
V _{(BR)EBO}	Emitter Base Breakdown Voltage (I _C = 0)	I _E = -10 mA		-5		-10	V
$V_{CEO(sus)^*}$	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = -10 mA L = 25 mH		-400			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = -0.5 A I _C = -0.35 A	I _B = -0.1 A I _B = -50 mA			-0.5 -0.5	V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = -0.5 A	I _B = -0.1 A			-1	V
h _{FE} *	DC Current Gain	$I_{C} = -10 \text{ mA}$ $I_{C} = -0.35 \text{ A}$ $I_{C} = -1 \text{ A}$	V _{CE} = -5 V V _{CE} = -5 V V _{CE} = -5 V	10 16 4	25	32	
t _r t _s t _f	RESISTIVE LOAD Rise Time Storage Time Fall Time	$I_{C} = -0.35 \text{ A}$ $I_{B1} = -70 \text{ mA}$ $T_{p} \ge 25 \mu \text{s}$	V _{CC} = 125 V I _{B2} = 70 mA (see Figure 2)	1.5	90 2.2 0.1	2.9	ns μs μs
t _s t _f	INDUCTIVE LOAD Storage Time Fall Time	$I_{C} = -0.5 \text{ A}$ $V_{BE(off)} = 5 \text{ V}$ $V_{clamp} = 300 \text{ V}$	I _{B1} = -0.1 A L = 10 mH (see Figure 1)		400 40		ns ns
E_{sb}	Avalanche Energy	L = 4 mH I _{BR} ≤ 2.5 A	C = 1.8 nF 25°C < T _C < 125°C	12			mJ

* Pulsed: Pulse duration = 300μ s, duty cycle = 1.5 %.

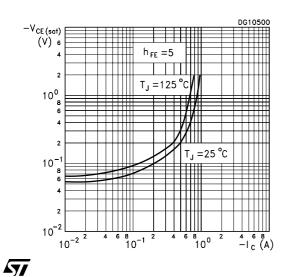


DC Current Gain

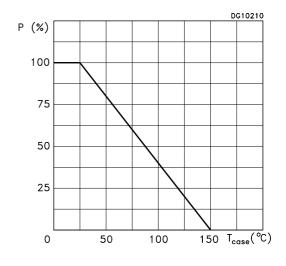
Safe Operating Area



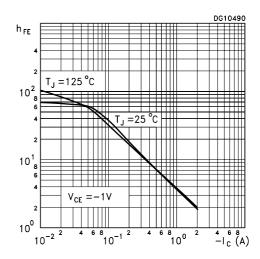
Collector Emitter Saturation Voltage



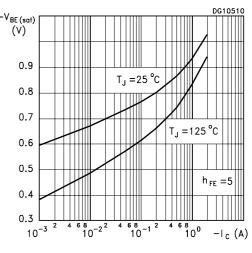
Derating Curve

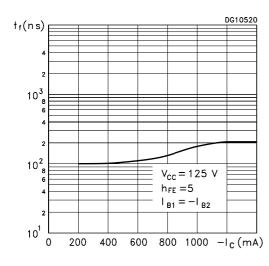


DC Current Gain



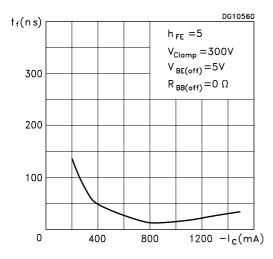
Base Emitter Saturation Voltage



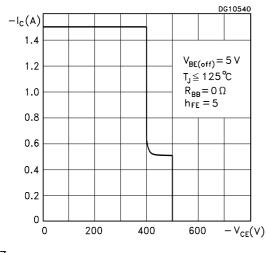


Resistive Load Fall Time

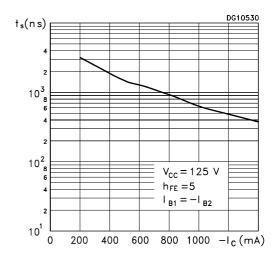
Inductive Load Fall Time



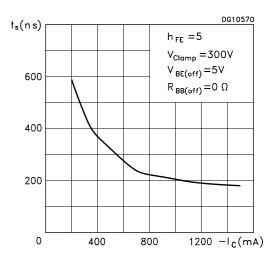
Reverse Biased SOA



Resistive Load Storage Time



Inductive Load Storage Time



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Figure 1: Inductive Load Switching Test Circuit.

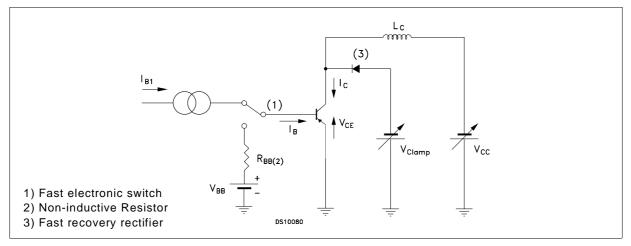
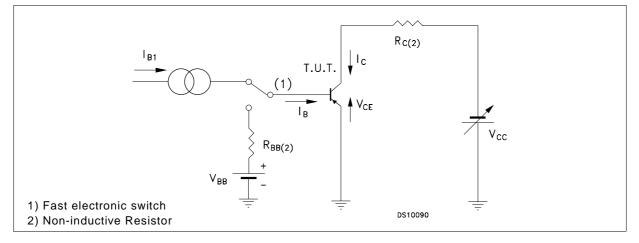


Figure 2: Resistive Load Switching Test Circuit.

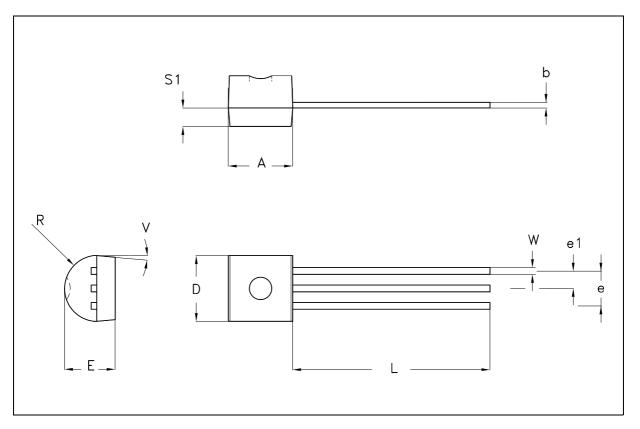
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DIM.	mm		inch			
	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.
А	4.32		4.95	0.170		0.195
b	0.36		0.51	0.014		0.020
D	4.45		4.95	0.175		0.194
E	3.30		3.94	0.130		0.155
е	2.41		2.67	0.095		0.105
e1	1.14		1.40	0.045		0.055
L	12.70		15.49	0.500		0.609
R	2.16		2.41	0.085		0.094
S1	1.14		1.52	0.045		0.059
W	0.41		0.56	0.016		0.022
V	4 degree		6 degree	4 degree		6 degree

TO-92 MECHANICAL DATA



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